



## 5N90

Preliminary

Power MOSFET

## 5A, 900V N-CHANNEL POWER MOSFET

### DESCRIPTION

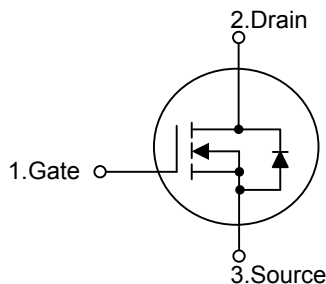
The UTC **5N90** is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **5N90** is universally applied in high efficiency switch mode power supply.

### FEATURES

- \*  $R_{DS(on)}=2.8\Omega$  @  $V_{GS}=10V$
- \* High switching speed
- \* Improved dv/dt capability
- \* 100% avalanche tested

### SYMBOL

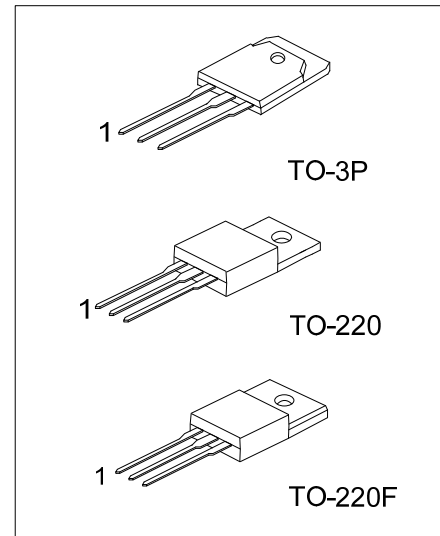


### ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
5N90L-TA3-T	5N90G-TA3-T	TO-220	G	D	S	Tube
5N90L-TF3-T	5N90G-TF3-T	TO-220F	G	D	S	Tube
5N90L-T3P-T	5N90G-T3P-T	TO-3P	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>5N90L-TA3-T</p> <p>(1) Packing Type (2) Package Type (3) Lead Free</p>	<p>(1) T: Tube (2) TA3: TO-220, TF3: TO-220F (3) G: Halogen Free, L: Lead Free</p>
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■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	900	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	Continuous	$I_D$	5	A
	Pulsed (Note 2)	$I_{DM}$	12	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	660	mJ
	Repetitive (Note 2)	$E_{AR}$	5.1	mJ
Peak Diode Recovery $dv/dt$ (Note 4)		$dv/dt$	4.0	V/ns
Power Dissipation	TO-220	$P_D$	125	W
	TO-220F		38	
	TO-3P		240	
Junction Temperature		$T_J$	+150	$^{\circ}\text{C}$
Storage Temperature		$T_{STG}$	-55~+150	$^{\circ}\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3.  $L=52.8\text{mH}$ ,  $I_{AS}=5\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^{\circ}\text{C}$

4.  $I_{SD}\leq 5.4\text{A}$ ,  $di/dt\leq 200\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^{\circ}\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/ TO-220F	$\theta_{JA}$	62.5	$^{\circ}\text{C}/\text{W}$
	TO-3P		40	
Junction to Case	TO-220	$\theta_{JC}$	1	$^{\circ}\text{C}/\text{W}$
	TO-220F		3.25	
	TO-3P		0.52	

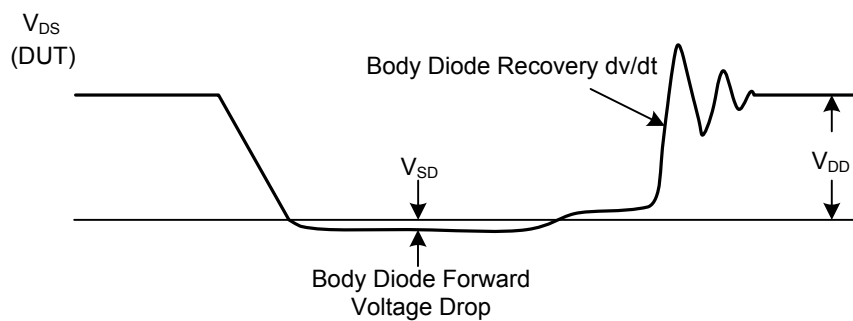
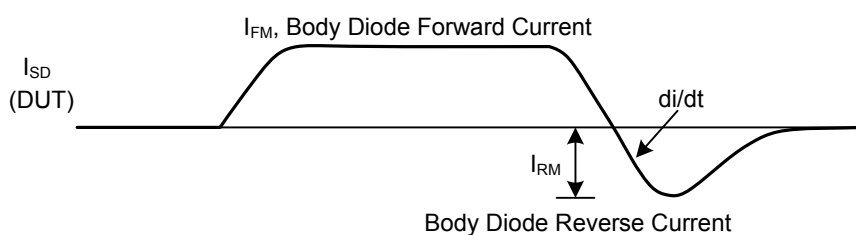
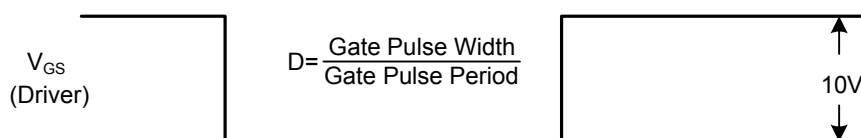
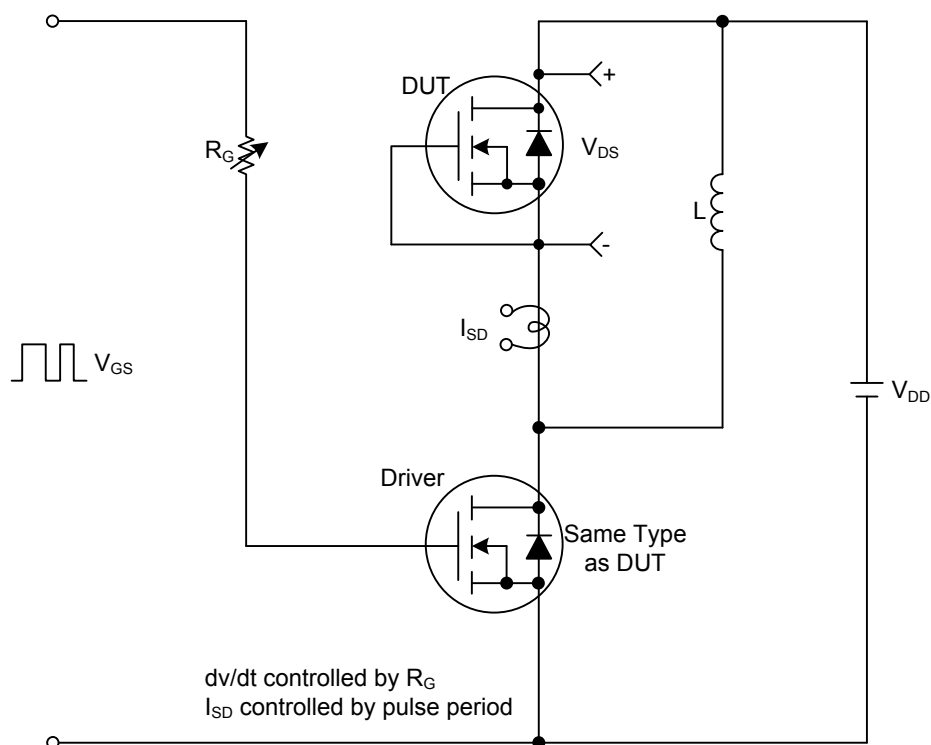
■ ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	900			V
Breakdown Voltage Temperature Coefficient		ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	I <sub>D</sub> =250μA, Referenced to 25°C		1.0		V/°C
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =900V, V <sub>GS</sub> =0V			10	μA
			V <sub>DS</sub> =720V, T <sub>C</sub> =125°C			100	μA
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>DS</sub> =0V , V <sub>GS</sub> =30V			100	nA
	Reverse		V <sub>DS</sub> =0V , V <sub>GS</sub> =-30V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	3.0		5.0	V
Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2.5A		2.25	2.8	Ω
Forward Transconductance		g <sub>FS</sub>	V <sub>DS</sub> =50V, I <sub>D</sub> =2.5A (Note 1)		4.0		S
DYNAMIC PARAMETERS							
Input Capacitance		C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		1200	1550	pF
Output Capacitance		C <sub>OSS</sub>			110	145	pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			13	17	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q <sub>G</sub>	V <sub>DS</sub> =720V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A (Note 1,2)		31	40	nC
Gate-Source Charge		Q <sub>GS</sub>			7.2		nC
Gate-Drain Charge		Q <sub>GD</sub>			15		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>	V <sub>DD</sub> =450V, I <sub>D</sub> =5A, R <sub>G</sub> =25Ω (Note 1,2)		28	65	ns
Turn-ON Rise Time		t <sub>R</sub>			65	140	ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>			65	140	ns
Turn-OFF Fall Time		t <sub>F</sub>			50	110	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I <sub>S</sub>				5	A
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				12	A
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	I <sub>S</sub> =5A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =5.4A,		610		ns
Body Diode Reverse Recovery Charge		Q <sub>RR</sub>	dI <sub>F</sub> /dt=100A/μs (Note 1)		5.26		μC

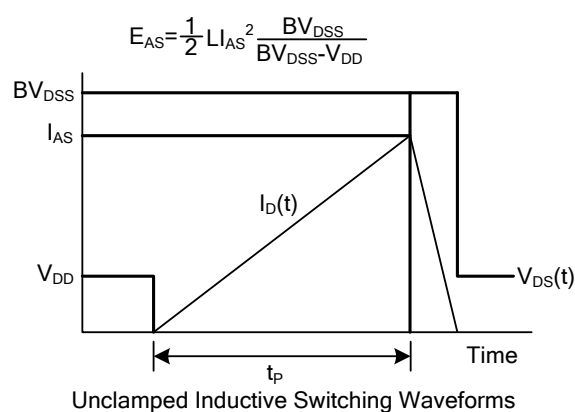
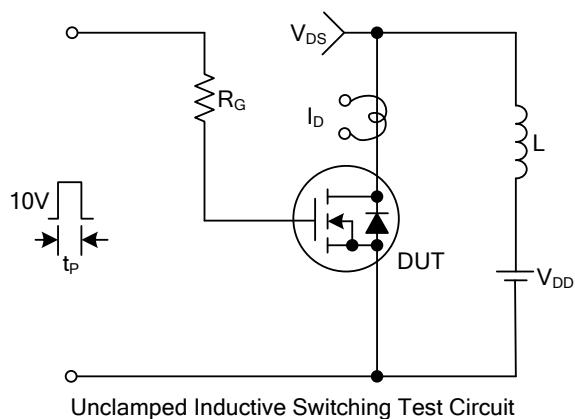
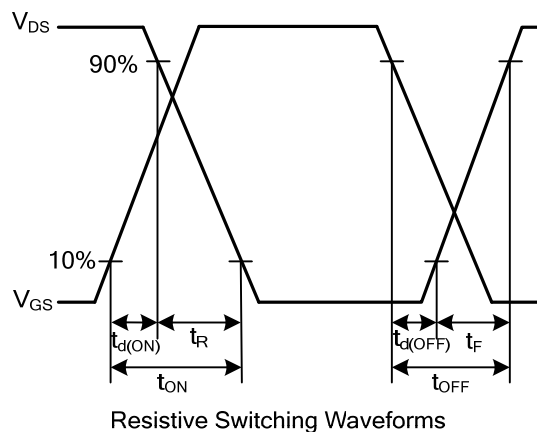
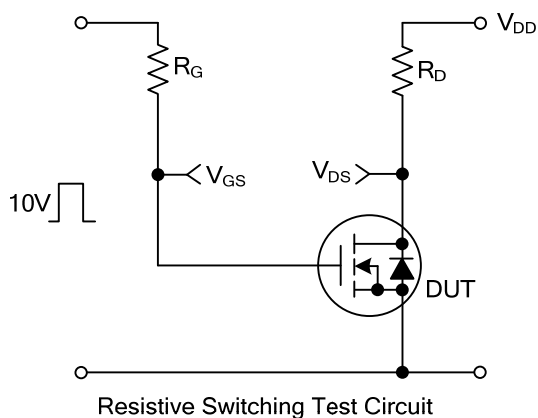
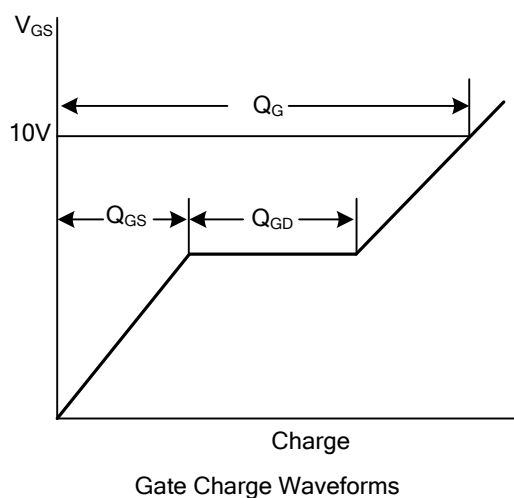
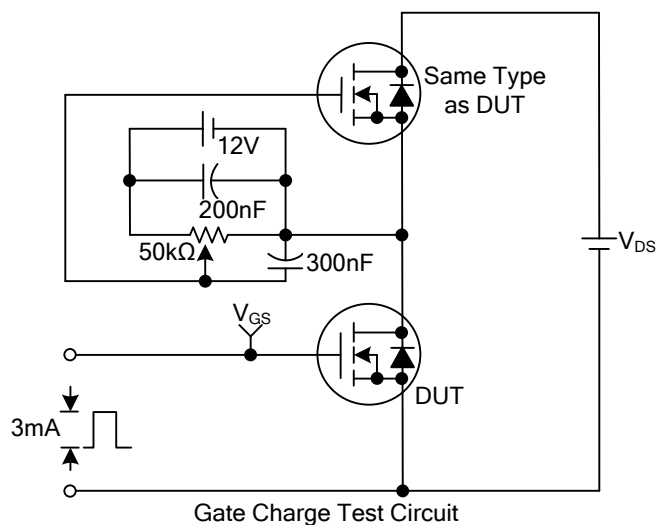
Note: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%

2. Essentially independent of operating temperature

# ■ TEST CIRCUITS AND WAVEFORMS

Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

# ■ TEST CIRCUITS AND WAVEFORMS(Cont.)



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